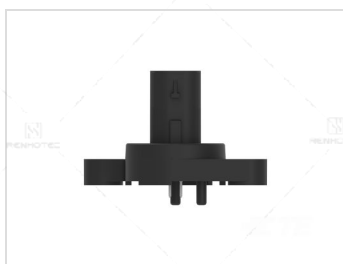




Vertical Wire-to-Board 4 Position 1 Row 2.54mm (.1in)  
Centerline Silver (Ag) Sealable Printed Circuit Board  
AMP MCP Hybrids

Part Number:

**TE-2366735-1**



## Basic Information

Number of Positions	4
Series	AMP
Tcpn	2366735-1
Product Description	2PORT, HYBRID, HDR ASSY, 180DEG, COD A, COD B
Connector System	Wire-to-Board
Number of Rows	1
PCB Mount Orientation	Vertical
Keying Code	2
Contact Type	Tab
Connector Mounting Type	Board Mount
Primary Product Color	Black
Mating Alignment	With
Connector Product Type	Connector Assembly
Header Type	Fully Shrouded
Mixed & Hybrid Header	No
Number of Signal Positions	4.0
Mounting Holes	With

### Mechanical Specification

Centerline (Pitch)	2.54 mm (.1 in.)
Mating Tab Width (mm)	1.2
Mating Tab Thickness (mm)	0.6
PCB Mount Alignment	With

### Material Specification

Contact Mating Plating	Silver (Ag)
UL Flammability Rating	UL 94HB

### Electrical Specification

Connector & Contact Terminates To	Printed Circuit Board
Contact Current Rating (Max) (A)	1.0
Termination Method to PCB	Through Hole - Solder
PCB Mount Retention	With
Circuit Application	Signal

### Environmental Specification

Sealable	Yes
Shielded	No
Operating Temperature Range	-40 – 125 °C (-40 – 257 °F)
Packaging Method	Tray

### Disclaimer

The information in this specification is subject to change without notice. Please confirm the latest version before use. Technical parameters are for reference only, and sufficient testing and verification should be conducted in actual applications.